

STGD7NB60H-1

N-CHANNEL 7A - 600V IPAK PowerMESHTM IGBT

ТҮРЕ	V _{CES}	V _{CE(sat)}	I _C					
STGD7NB60H-1	600 V	< 2.8 V	7 A					

- HIGH INPUT IMPEDANCE (VOLTAGE DRIVEN)
- (VOLTAGE DRIVEN) LOW ON-VOLTAGE DROP (V_{cesat})
- LOW GATE CHARGE
- HIGH CURRENT CAPABILITY
- VERY HIGH FREQUENCY OPERATION
- OFF LOSSES INCLUDE TAIL CURRENT
- THROUGH-HOLE IPAK (TO-251) POWER PACKAGE IN TUBE (SUFFIX"-1")

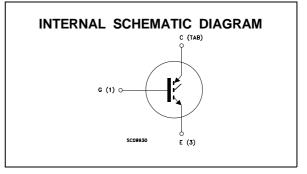
DESCRIPTION

Using the latest high voltage technology based on a patented strip layout, STMicroelectronics has designed an advanced family of IGBTs, the PowerMESHTM IGBTs, with outstanding perfomances. The suffix "H" identifies a family optimized to achieve very low switching times for high frequency applications (<120kHz).

APPLICATIONS

- HIGH FREQUENCY MOTOR CONTROLS
- SMPS AND PFC IN BOTH HARD SWITCH AND RESONANT TOPOLOGIES

IPAK TO-251 (Suffix "-1")	



Symbol	Parameter	Value	Unit
V _{CES}	Collector-Emitter Voltage (V _{GS} = 0)	600	V
Vecr	Emitter-Collector Voltage	20	V
V _{GE}	Gate-Emitter Voltage	± 20	V
Ι _C	Collector Current (continuous) at T _c = 25 °C	14	А
Ι _C	Collector Current (continuous) at T _c = 100 °C	7	А
I _{СМ} (●)	Collector Current (pulsed)	56	А
P _{tot}	Total Dissipation at $T_c = 25$ °C	55	W
	Derating Factor	0.44	W/ºC
T _{stg}	Storage Temperature	-65 to 150	°C
Tj	Max. Operating Junction Temperature	150	°C

ABSOLUTE MAXIMUM RATINGS

(•) Pulse width limited by safe operating area

THERMAL DATA

R _{thj-case}	Thermal Resistance Junction-case	Max	2.27	°C/W
R _{thj-amb}	Thermal Resistance Junction-ambient	Max	100	°C/W
R _{thc-sink}	Thermal Resistance Case-sink	Тур	1.5	°C/W

ELECTRICAL CHARACTERISTICS (T_j = 25 $^{\circ}$ C unless otherwise specified) OFF

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
VBR(CES)	Collector-Emitter Breakdown Voltage	$I_{C} = 250 \ \mu A$ $V_{GE} = 0$	600			V
I _{CES}	Collector cut-off (V _{GE} = 0)				10 100	μΑ μΑ
I _{GES}	Gate-Emitter Leakage Current (V _{CE} = 0)	$V_{GE} = \pm 20 \text{ V} \qquad \qquad V_{CE} = 0$			± 100	nA

ON (*)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
$V_{\text{GE(th)}}$	Gate Threshold Voltage	$V_{CE} = V_{GE}$ I _C = 250 µA	3		5	V
V _{CE(SAT)}	Collector-Emitter Saturation Voltage	$ \begin{array}{ll} V_{GE} = 15 \ V & I_C = 7 \ A \\ V_{GE} = 15 \ V & I_C = 7 \ A & T_j = 125 \ ^{o}C \end{array} $		2.3 1.9	2.8	V V

DYNAMIC

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
g fs	Forward Transconductance	V _{CE} =25 V I _C = 7 A	3.5	5		S
C _{ies} C _{oes} C _{res}	Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{CE} = 25 V$ f = 1 MHz $V_{GE} = 0$	390 45 10	560 68 15	730 90 20	pF pF pF
Q _G Q _{GE} Q _{GC}	Total Gate Charge Gate-Emitter Charge Gate-Collector Charge	$V_{CE} = 480 \text{ V}$ $I_C = 7 \text{ A}$ $V_{GE} = 15 \text{ V}$		42 7.9 17.6	55	nC nC nC
I _{CL}	Latching Current		28			A

SWITCHING ON

Symbol	Parameter	Test Con	Min.	Тур.	Max.	Unit	
t _{d(on)} t _r	Delay Time Rise Time	V _{CC} = 480 V V _{GE} = 15 V	$I_{C} = 7 A$ $R_{G} = 10\Omega$		15 48		ns ns
(di/dt) _{on}	Turn-on Current Slope	V _{CC} = 480 V R _G = 10 Ω	I _C = 7 A V _{GE} = 15 V		160		A/µs
Eon	Turn-on Switching Losses	T _j = 125 °C			70		μJ

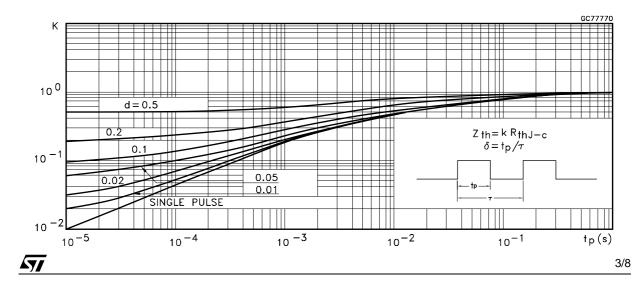
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ELECTRICAL CHARACTERISTICS (continued) SWITCHING OFF

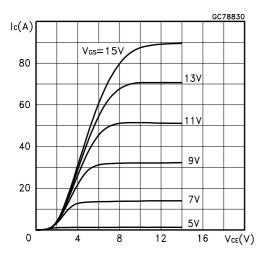
Symbol	Parameter	Test Cor	Min.	Тур.	Max.	Unit	
tc	Cross-Over Time	VCC = 480 V	I _C = 7 A		85		ns
t _r (v _{off})	Off Voltage Rise Time	$R_{GE} = 10 \Omega$	V _{GE} = 15 V		20		ns
t _d (off)	Delay Time				75		ns
t _f	Fall Time				70		ns
E _{off} (**)	Turn-off Switching Loss				85		μJ
Ets	Total Switching Loss				130		μJ
tc	Cross-Over Time	VCC = 480 V	I _C = 7 A		150		ns
t _r (v _{off})	Off Voltage Rise Time	$R_{GE} = 10 \Omega$	V _{GE} = 15 V		50		ns
t _d (off)	Delay Time	T _i = 125 °C			110		ns
t _f	Fall Time				110		ns
E _{off} (**)	Turn-off Switching Loss				220		μJ
Ets	Total Switching Loss				290		μJ

(•) Pulse width limited by max. junction temperature (*) Pulsed: Pulse duration = $300 \ \mu$ s, duty cycle 1.5 % (**)Losses Include Also The Tail (Jedec Standardization)

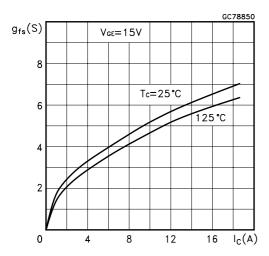
Thermal Impedance



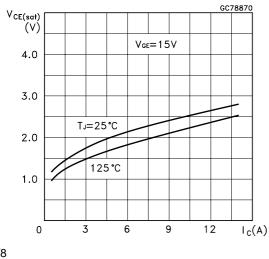
Output Characteristics



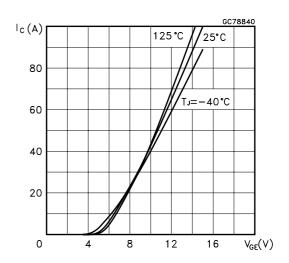
Transconductance



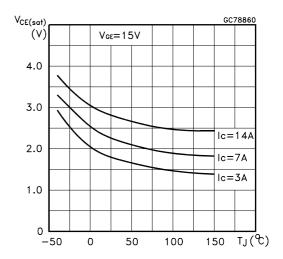
Collector-Emitter On Voltage vs Collector Current

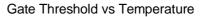


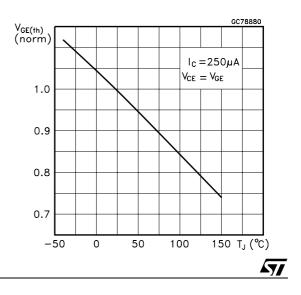
Transfer Characteristics

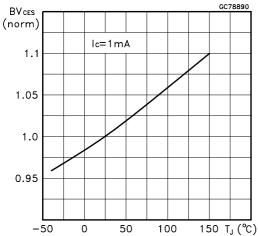


Collector-Emitter On Voltage vs Temperature



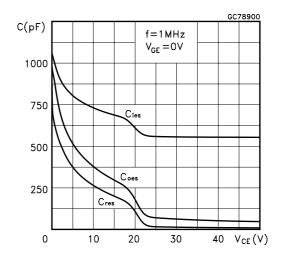




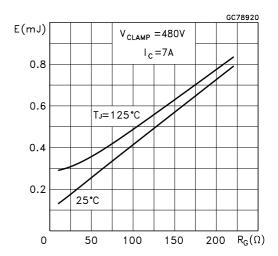


Normalized Breakdown Voltage vs Temperature

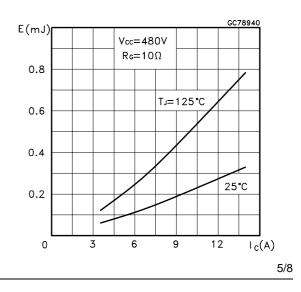
Capacitance Variations



Total Switching Losses vs Gate Resistance

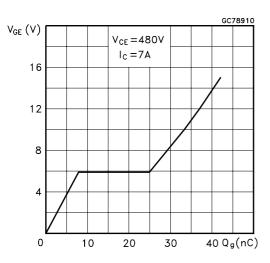


Total Switching Losses vs Collector Current

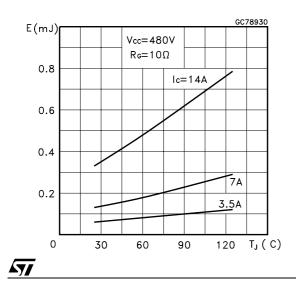


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Total Switching Losses vs Temperature



Switching Off Safe Operating Area

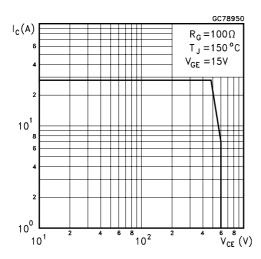
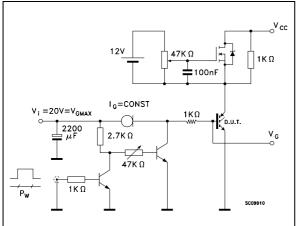
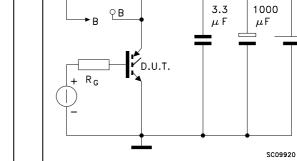


Fig. 1: Gate Charge test Circuit





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►A 0A

FAST DIODE

Fig. 3: Switching Waveforms

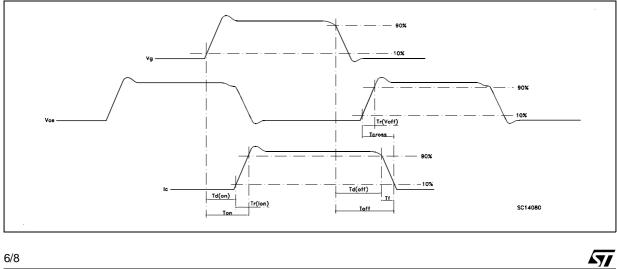


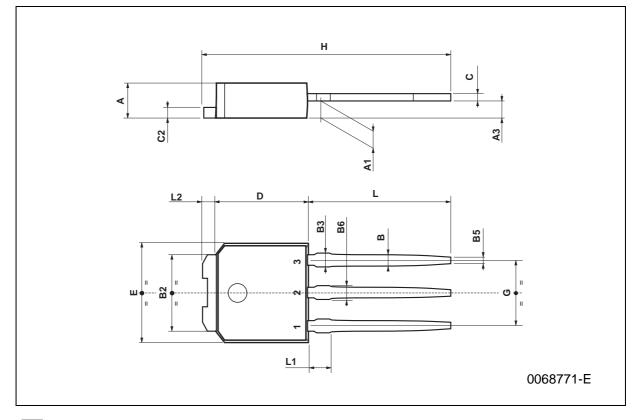
Fig. 2: Test Circuit For Inductive Load Switching

L=100µH

 v_{cc}

DIM.		mm			inch	
Dilvi.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А	2.2		2.4	0.086		0.094
A1	0.9		1.1	0.035		0.043
A3	0.7		1.3	0.027		0.051
В	0.64		0.9	0.025		0.031
B2	5.2		5.4	0.204		0.212
B3			0.85			0.033
B5		0.3			0.012	
B6			0.95			0.037
С	0.45		0.6	0.017		0.023
C2	0.48		0.6	0.019		0.023
D	6		6.2	0.236		0.244
E	6.4		6.6	0.252		0.260
G	4.4		4.6	0.173		0.181
Н	15.9		16.3	0.626		0.641
L	9		9.4	0.354		0.370
L1	0.8		1.2	0.031		0.047
L2		0.8	1		0.031	0.039

TO-251 (IPAK) MECHANICAL DATA



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